

**HIGH FREQUENCY HIGH-SIDE AND LOW-SIDE GATE DRIVER IN V-QFN3030-8**
**Description**

The DGD0590A is a high-frequency high-side and low-side gate driver capable of driving N-channel MOSFETs in a half-bridge configuration. The floating high-side driver is rated up to 40V and provides a 5V gate drive to the MOSFETs.

The DGD0590A logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) to interface easily with MCUs. A UVLO will protect ICs and MOSFETs with loss of supply.

Fast and well-matched propagation delays allow a higher switching frequency, enabling a smaller, more compact power switching design, using smaller associated components. The DGD0590A is offered in the V-QFN3030-8 package and operates over an extended -40°C to +125°C temperature range.

**Applications**

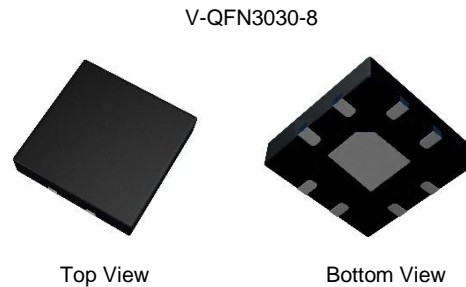
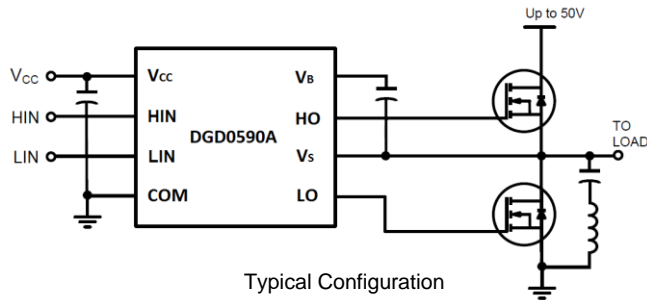
- Wireless Power Charger
- Motor Drive
- Logic Level MOSFET Gate Driver

**Features**

- 40V Floating High-Side Driver
- Low  $V_{CC}$  Operating Voltage: 4.5V to 5.5V
- Drives Two N-channel Logic Level MOSFETs in a Half-Bridge Configuration
- High-Side 1.0A Source / 1.0A Sink and Low-Side 1.0A Source / 3.0A Sink Output Current Capability
- Internal Bootstrap Diode Included
- 3.4V UVLO with 0.4V Hysteresis
- Fast Rise and Fall Times (27ns/17ns) with 3nF Load
- Propagation Delay Typical of 16ns for High-Side and 12ns for Low-Side
- Extended Temperature Range: -40°C to +125°C
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

**Mechanical Data**

- Case: V-QFN3030-8 (Type TH)
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish – Matte Tin Finish. Solderable per MIL-STD-202, Method 208
- Weight: 0.017 grams (Approximate)


**Ordering Information** (Note 4)

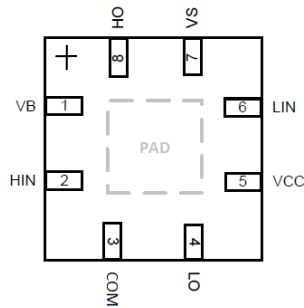
Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DGD0590AFU-7	DGD0590A	7	8	3,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

**Marking Information**


DGD0590A = Product Type Marking Code  
 YY = Year (ex: 19 = 2019)  
 WW = Week (01 to 53)

## Pin Diagrams

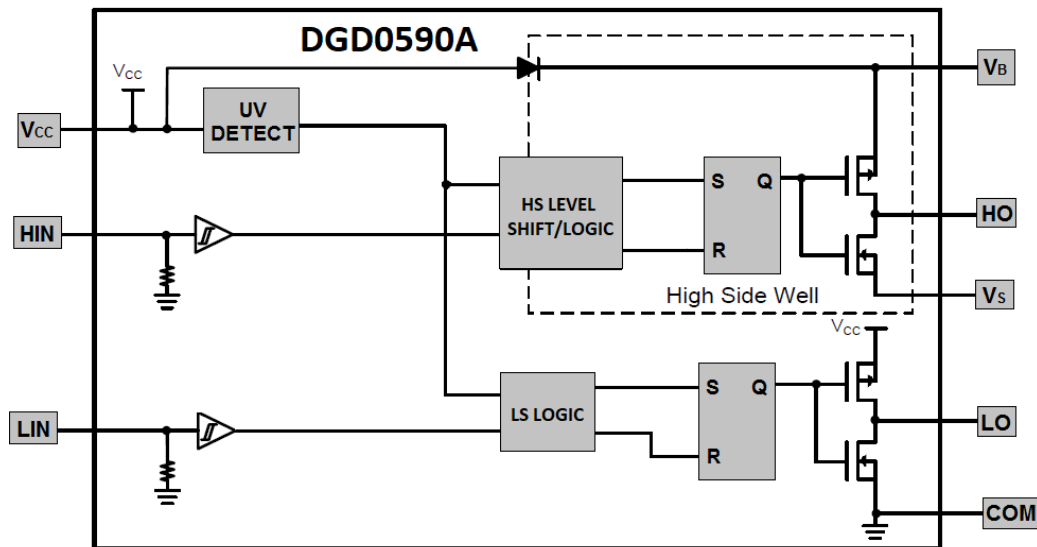


Top View: V-QFN3030-8

## Pin Descriptions

Pin Number	Pin Name	Function
1	VB	High-Side Floating Supply
2	HIN	Logic Input for High-Side Gate Driver, in Phase with HO, Pull Down Resistor at Input
3	COM	Low-Side and Logic Return
4	LO	Low-Side Gate Driver Output
5	VCC	Low-Side and Logic Supply
6	LIN	Logic Input for Low-Side Gate Driver, in Phase with LO, Pull Down Resistor at Input
7	VS	High-Side Floating Supply Return
8	HO	High-Side Gate Driver Output
PAD	Substrate	Connect to COM on PCB

## Functional Block Diagram



**Absolute Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Positive Supply Voltage	$V_B$	0.3 to +50	V
High-Side Floating Negative Supply Voltage	$V_S$	$V_B - 6$ to $V_B + 0.3$	V
High-Side Floating Output Voltage	$V_{HO}$	$V_S - 0.3$ to $V_B + 0.3$	V
Offset Supply Voltage Transient	$dV_S / dt$	50	V/ns
Logic and Low-Side Fixed Supply Voltage	$V_{CC}$	-0.3 to +6	V
Low-Side Output Voltage	$V_{LO}$	-0.3 to $V_{CC} + 0.3$	V
Logic Input Voltage (HIN and LIN)	$V_{IN}$	-0.3 to +6	V

**Thermal Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	120	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction to Case (Note 5)	$R_{\theta JC}$	132	$^\circ\text{C}/\text{W}$
Operating Temperature	$T_J$	+150	$^\circ\text{C}$
Lead Temperature (Soldering, 10s)	$T_L$	+300	
Storage Temperature Range	$T_{STG}$	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

**Recommended Operating Conditions**

Parameter	Symbol	Min	Max	Unit
High-Side Floating Supply	$V_B$	$V_S + 4.5$	$V_S + 5.5$	V
High-Side Floating Supply Offset Voltage	$V_S$	0	40 (Note 6)	V
High-Side Floating Output Voltage	$V_{HO}$	$V_S$	$V_B$	V
Logic and Low Side Fixed Supply Voltage	$V_{CC}$	4.5	5.5	V
Low-Side Output Voltage	$V_{LO}$	0	$V_{CC}$	V
Logic Input Voltage (HIN and LIN)	$V_{IN}$	0	5	V
Ambient Temperature	$T_A$	-40	+125	$^\circ\text{C}$

Note: 6. Provided  $V_B$  doesn't exceed absolute maximum rating of 50V.

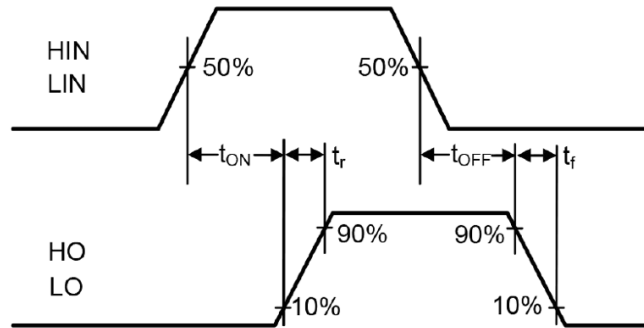
**DC Electrical Characteristics** ( $V_{CC} = 5V$ ,  $@T_A = +25^\circ C$ , unless otherwise specified.)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Logic "1" Input Voltage, HIN	$V_{HIH}$	—	3.5	3.8	V	—
Logic "0" Input Voltage, HIN	$V_{HIL}$	1.0	1.3	—	V	—
Logic "1" Input Voltage, LIN	$V_{LIH}$	—	2.8	3.3	V	—
Logic "0" Input Voltage, LIN	$V_{LIL}$	1.0	1.2	—	V	—
Logic Input Bias Current	$I_{IN+}$	—	31	60	$\mu A$	$V_{IN} = V_{CC}$
$V_{CC}$ Quiescent Supply Current	$I_{CCQ}$	—	22	50	$\mu A$	—
$V_{CC}$ Operating Supply Current	$I_{CCO}$	—	300	—	$\mu A$	HO and LO Open, $f_s = 250kHz$
High-Side Source Impedance	$R_{HSO}$	—	1.8	2.6	$\Omega$	$I_{SOURCE} = 100mA$
High-Side Sink Impedance	$R_{HSI}$	—	1.5	2.1	$\Omega$	$I_{SINK} = 100mA$
Low-Side Source Impedance	$R_{LSO}$	—	1.8	2.6	$\Omega$	$I_{SOURCE} = 100mA$
Low-Side Sink Impedance	$R_{LSI}$	—	0.4	1.0	$\Omega$	$I_{SINK} = 100mA$
$V_{CC}$ Supply Undervoltage Positive Going Threshold	$V_{CCUV+}$	2.85	3.4	3.85	V	—
$V_{CC}$ Supply Undervoltage Hysteresis	$V_{CCU\_HYST}$	—	0.4	—	V	—
Bootstrap Diode Forward Voltage	$V_{BFD}$	—	650	800	mV	$I = 100\mu A$
Bootstrap Diode Reverse Leakage	$I_{BDL}$	—	0.1	0.4	$\mu A$	$V_B = V_S = 45.5V$ , $V_{CC} = 0V$

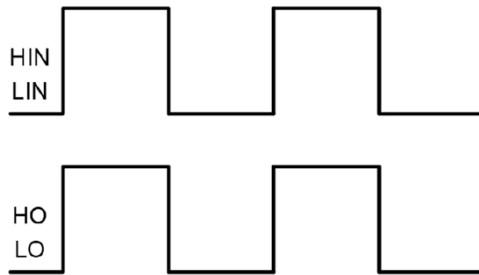
**AC Electrical Characteristics** ( $V_{CC} = 5V$ ,  $C_L = 3nF$ ,  $@T_A = +25^\circ C$ , unless otherwise specified.)

Parameter	Symbol	Min	Typ	Max	Unit	Conditions
Turn-On Rise Time	$t_R$	—	27	—	ns	—
Turn-Off Fall Time, High-Side	$t_F$	—	29	—	ns	—
Turn-Off Fall Time, Low-Side		—	17	—	ns	—
Turn-On Propagation Delay Time, High-Side	$t_{ONH}$	—	16	—	ns	—
Turn-Off Propagation Delay Time, High-Side	$t_{OFFH}$	—	17	—	ns	—
Turn-On Propagation Delay Time, Low-Side	$t_{ONL}$	—	12	—	ns	—
Turn-Off Propagation Delay Time, Low-Side	$t_{OFFL}$	—	17	—	ns	—

**Timing Waveforms**

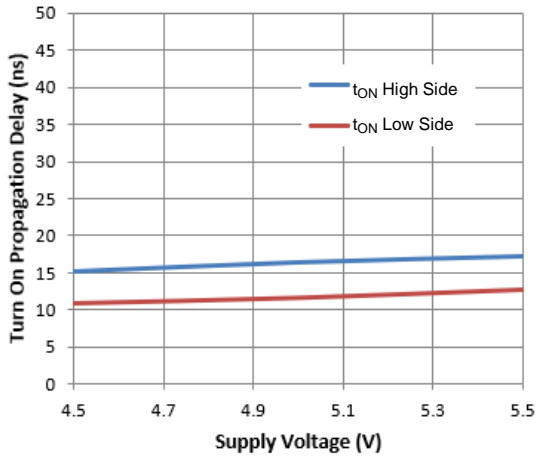


**Figure 1.** Switching Time Waveform Definitions

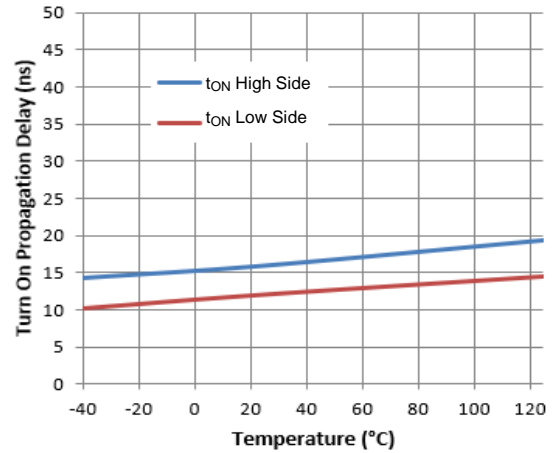


**Figure 2.** Input / Output Timing Diagram

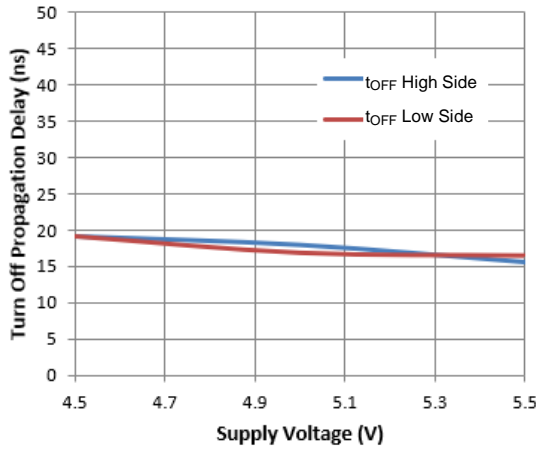
**Typical Performance Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)



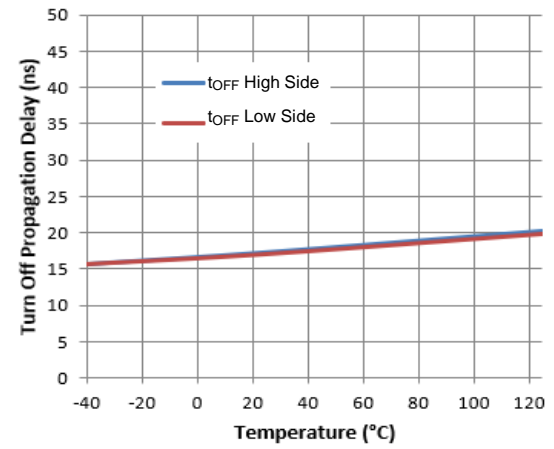
**Figure 3.** Turn-on Propagation Delay vs. Supply Voltage



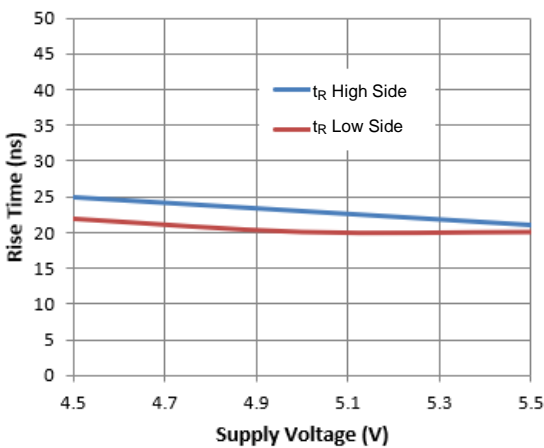
**Figure 4.** Turn-on Propagation Delay vs. Temperature



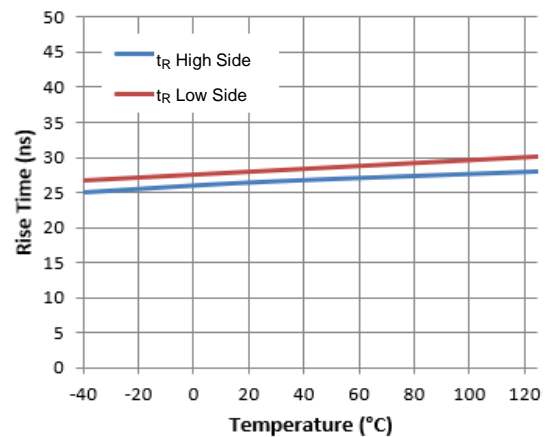
**Figure 5.** Turn-off Propagation Delay vs. Supply Voltage



**Figure 6.** Turn-off Propagation Delay vs. Temperature

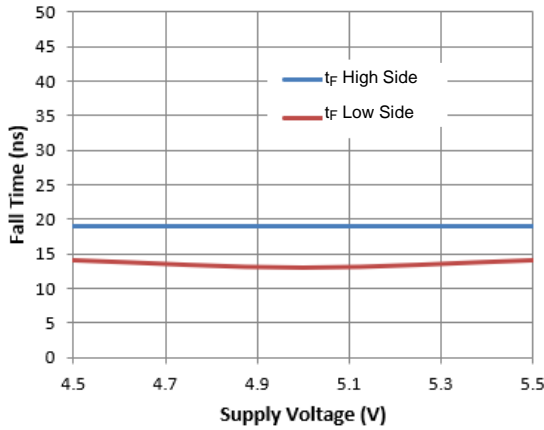


**Figure 7.** Rise Time vs. Supply Voltage

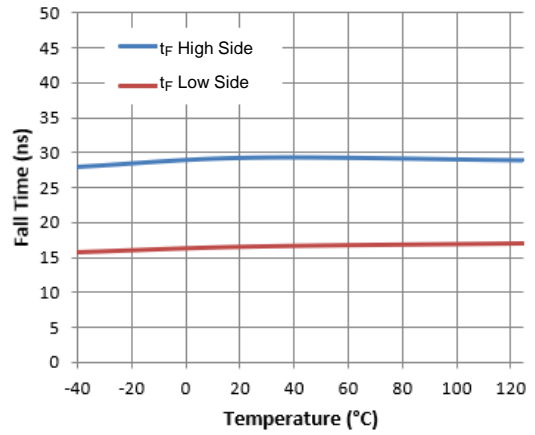


**Figure 8.** Rise Time vs. Temperature

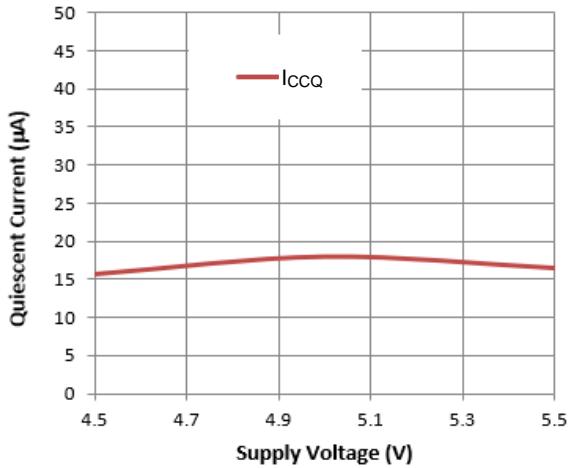
**Typical Performance Characteristics** (continued)



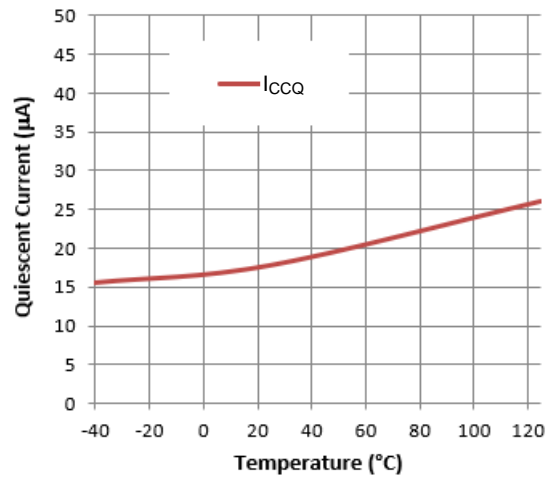
**Figure 9.** Fall Time vs. Supply Voltage



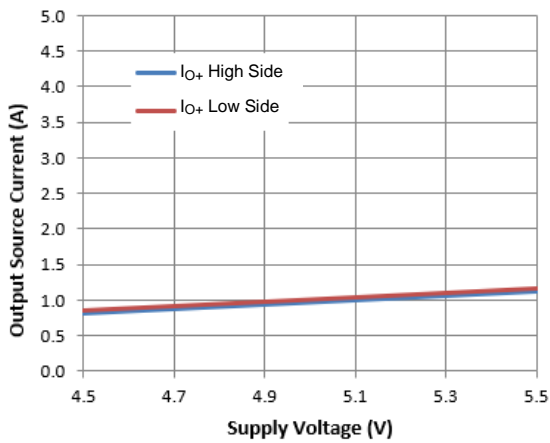
**Figure 10.** Fall Time vs. Temperature



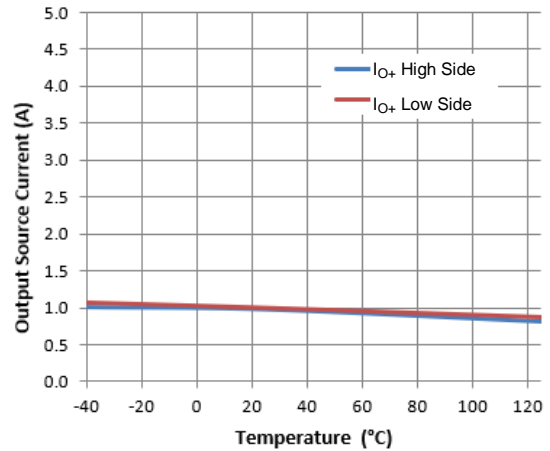
**Figure 11.** Quiescent Current vs. Supply Voltage



**Figure 12.** Quiescent Current vs. Temperature

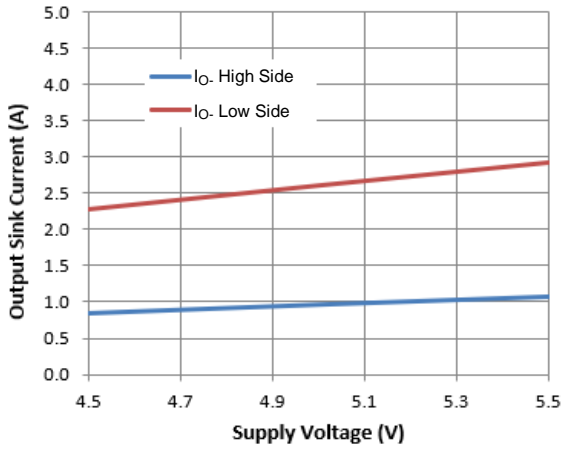


**Figure 13.** Output Source Current vs. Supply Voltage

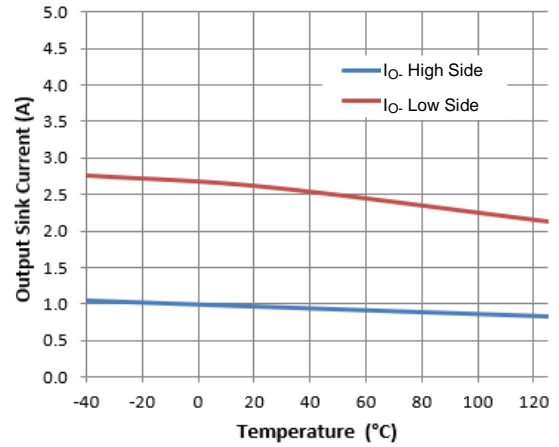


**Figure 14.** Output Source Current vs. Temperature

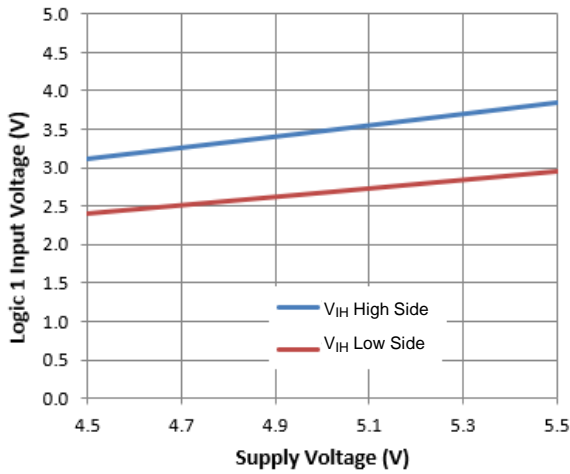
**Typical Performance Characteristics** (continued)



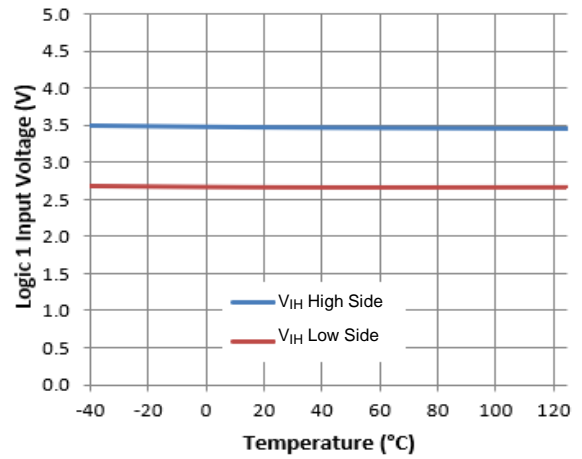
**Figure 15.** Output Sink Current vs. Supply Voltage



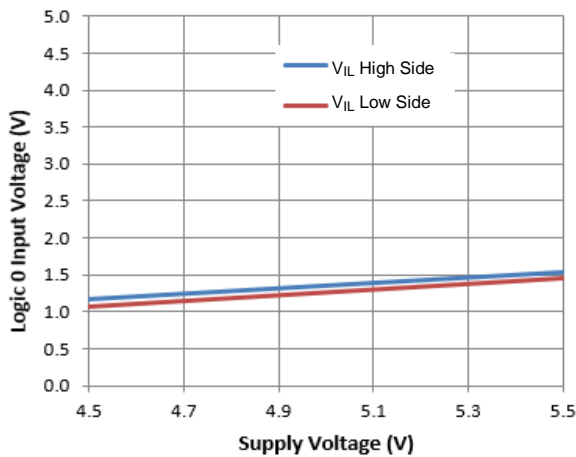
**Figure 16.** Output Sink Current vs. Temperature



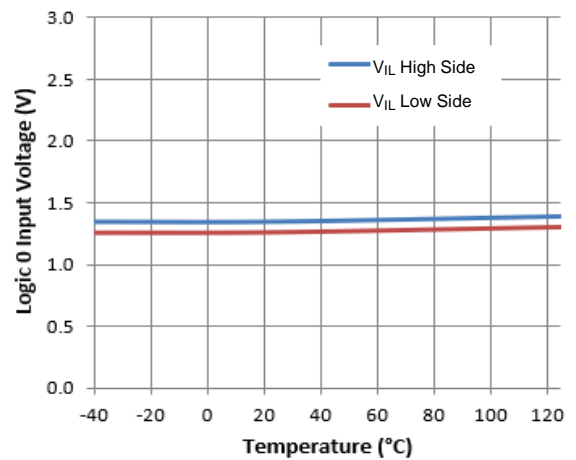
**Figure 17.** Logic 1 Input Voltage vs. Supply Voltage



**Figure 18.** Logic 1 Input Voltage vs. Temperature



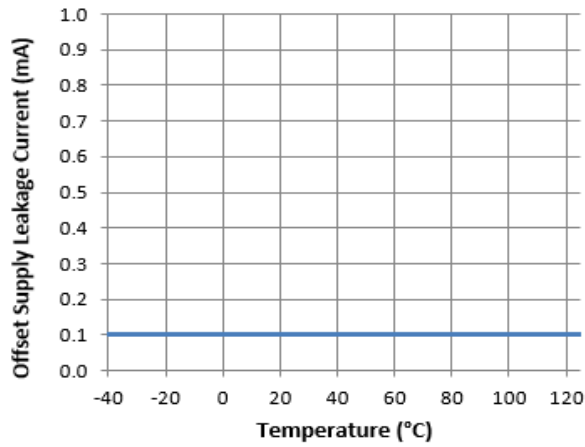
**Figure 19.** Logic 0 Input Voltage vs. Supply Voltage



**Figure 20.** Logic 0 Input Voltage vs. Temperature



**Typical Performance Characteristics** (continued)

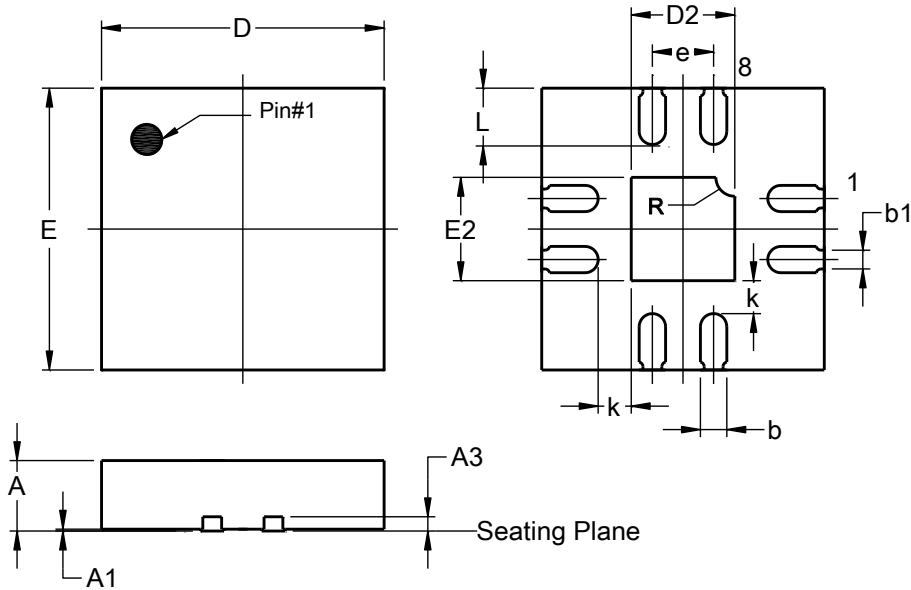


**Figure 21.** Offset Supply Leakage Current vs. Temperature

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

V-QFN3030-8 (Type TH)

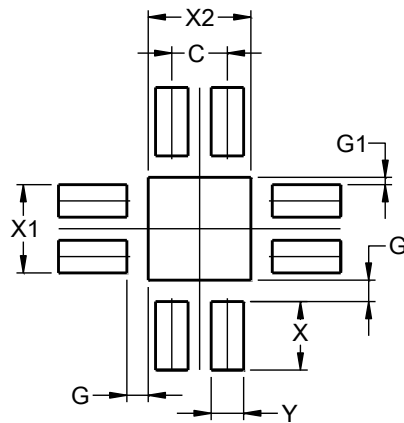


V-QFN3030-8 (Type TH)			
Dim	Min	Max	Typ
A	0.70	0.80	0.75
A1	0.00	0.05	0.02
A3	0.203REF		
b	0.23	0.33	0.28
b1	0.20REF		
D	2.90	3.10	3.00
D2	1.00	1.20	1.10
E	2.90	3.10	3.00
E2	1.00	1.20	1.10
e	0.65BSC		
L	0.55	0.65	0.60
k	0.30	0.40	0.35
R	0.20REF		
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

V-QFN3030-8 (Type TH)



Dimensions	Value (in mm)
C	0.650
G	0.250
G1	0.085
X	0.800
X1	1.030
X2	1.200
Y	0.380

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